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| |  | | --- | | **Development Procedure** | |  | |
| **FOR EDUCATIONAL USE ONLY** |

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| This document is available for free as a download from the GitHub repository: <https://github.com/miniPCB>  This document is associated with the miniPCB Channel on YouTube:  <https://www.youtube.com/@minipcb> |

TABLE OF CONTENTS

[1. Purpose 4](#_Toc149464163)

[2. Scope 4](#_Toc149464164)

[3. Responsibilities 4](#_Toc149464165)

[4. Terminology and Abbreviations 4](#_Toc149464166)

[5. Procedural Notes 5](#_Toc149464167)

[6. Procedure 6](#_Toc149464168)

[7. References 7](#_Toc149464169)

[8. Change and Liability Notice 8](#_Toc149464170)

[9. Trademark Notice 8](#_Toc149464171)

[10. Revision History 9](#_Toc149464172)

[11. Related Content 10](#_Toc149464173)

TABLE OF FIGURES

**TABLE OF TABLES**

[Table 1 – Definitions and Abbreviations 4](#_Toc149464175)

# Purpose

The purpose of this document is to provide a development procedure for developing miniPCBs.

# Scope

This document applies to development activities related to the miniPCB project.

# Responsibilities

**Chief Engineer** is responsible for maintaining this procedure.

**Engineer** developing miniPCBs is responsible for adhering to this procedure.

# Terminology and Abbreviations

Terminology and abbreviations used throughout the miniPCB project are consistent with the definitions presented in this section.

Table – Definitions and Abbreviations

|  |  |
| --- | --- |
| TERM | DEFINITION |
| PCB | Printed Circuit Board, Bare Board |
| PCBA | Printed Circuit Board Assembly, Bare Board + Parts + Assembly |
| SMD | Surface mount device |
| THD | Through hole device |

# Procedural Notes

## Order of Operations

The development procedure starts at kickoff, EE0.0, and proceeds forward through the milestones EE1.0, EE2.0, EE3.0, and EE4.0. Any milestone may be repeated as many times as necessary, and any project can be cancelled, to ensure that Quality Objectives are satisfied.

## Design Standards

The miniPCB Design Standard shall be maintained and adhered to.

## Collaboration

Collaborator(s) are welcome at every development stage.

## Engineering Release

Approval on the ECObase engineering change order is the action that releases the miniPCB design.

## YouTube Videos

Videos of work may be recorded.

## YouTube Channel

Videos may be uploaded to a YouTube channel.

# Procedure

## EE0.0 Kickoff

EE0.0 milestone deliverables list:

* Engineering Change Order, Requested
* GitHub update

## EE1.0 Preliminary Design Review

EE1.0 milestone deliverables list:

* EAGLE project
* Schematic
* Layout
* Datasheet
* Fabrication files
* GitHub update
* Datasheet with Parts List
* Engineering Change Order, DR approval

## EE2.0 Critical Design Review

EE2.0 milestone deliverables list:

* Developmental Test Plan created
* Developmental Test Report created
* Datasheet with Test Results
* Engineering Change Order, DR approval

## EE3.0 Final Design Review

EE3.0 milestone deliverables list:

* Developmental Test Plan
* Developmental Test Report
* Datasheet complete
* Engineering Change Order, ENG approval

## EE4.0 Hardware Release

EE4.0 milestone deliverables list:

* Engineering Change Order, QA approval

The development work is complete.

# References

miniPCB™ Design Standard

miniPCB™ Product Catalog

ECObase Template

TESTbase Template

# Change and Liability Notice

This document is subject to change without notice. While effort has been made to ensure the accuracy of the material contained within this document, Nolan Manteufel shall under no circumstances be liable for incidental or consequential damages or related expenses resulting from the use of this document.

# Trademark Notice

miniPCB is a trademark of Nolan Manteufel.

This document does not constitute permission to use the miniPCB trademark.

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| WORDMARK | FIGUREMARK | FIGUREMARK |
| miniPCB™ | A picture containing drawing  Description automatically generated™ | Icon  Description automatically generated™ |

# Revision History

|  |  |  |  |
| --- | --- | --- | --- |
| REV | DESCRIPTION | ECO | DATE |
| A | Initial Release | 1013 | 15JAN2023 |
| B | Moved sections included in Initial Release to the miniPCB Quality Manual.  Added sections Idea, Prototype, Released, and Obsolete phases. | 1015 | 16JAN2023 |
| C | Removed sections related to product life cycle and added procedural notes, EE# milestones with lists of deliverables, incorporated ECObase, and added related content section. | 1022 | 28FEB2023 |
| D | Rewrote the procedure. | 1024 | 29OCT2023 |

# Related Content

|  |  |  |  |
| --- | --- | --- | --- |
| # | TYPE | DESCRIPTION | LOCATION |
| 1 | Video | Initial drafting | https://youtu.be/Nu3xy9QKs2k |
| 2 | Video | Initial release | https://youtu.be/nyEXWn2ROAk |
| 3 | Video | Drafting, Rev C | https://youtu.be/oAd69bdk28s |
| 4 | Video | Release, Rev C | https://youtu.be/yXWtaEAUBHY |